



NO.PT-A-005-7



# History of Version

Date	Ver.	Description	Page	Design by
2007/8/3	0	MASS PRODUCTION.	-	Jared

Total: 28 Page



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Note : For detailed information please refer to IC data sheet :

Primacy(TFT LCD): Himax: HX8238-A



## **1. SPECIFICATIONS**

#### 1.1 Features

#### Main LCD panel

Item	Standard Value
Display Type	320(R、G、B) * 240 Dots
LCD Type	Normally white, Transmissive type
Screen size(inch)	3.5 inch
Viewing Direction	6 O'clock
Color configuration	RGB-Strip
Backlight	LED
Interface	Digital 24-bits RGB
Other(controller/driver IC)	Himax: HX8238-A
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer web side :
	http://www.powertip.com.tw/news/LatestNews.asp

# 1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	76.9(W) * 63.9 (L) * 4.75 (H)(MAX)	mm

#### LCD panel

Item	Standard Value	Unit
Viewing Area	72.88 (W) * 55.36 (L)	mm
Active Area	70.08 (W) * 52.56 (L)	mm

#### **Touch panel**

Item	Standard Value	Unit
Viewing Area	72.0 (W) x 54.56 (H)	mm
Active Area	70.08 (W) x 53.26 (L)	mm

Note : For detailed information please refer to LCM drawing



#### **Absolute Maximum Ratings** 1.3

#### Module

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VDDIO	VSS=0	-0.3	4.0	V
Input Voltage	Vi	-	-0.3	5.0	V
Operating Temperature	T <sub>OP</sub>	-	-20	70	°C
Storage Temperature	T <sub>ST</sub>	-	-30	80	°C

#### **DC Electrical Characteristics** 1.4

## VSS = 0V Ta = 25°C

Module		VSS = 0V, Ta = 25°C			)	
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage1	VDDIO	-	3.0	3.3	3.6	V
Vсом High Voltage	Vсомн	-	2.5	(3.6)	4.5	V
VCOM Low Voltage	VCOML	-	-3	(-2.4)	0	V
Supply Current	IDD	VDD = 3.3 V Pattern= black *1	-	5.5	8.5	mA

Note1:Maximum current display



# **1.5 Optical Characteristics**

### TFT LCD Module

VDDIO=3.3V, Ta=25°C

Item		Symbol	Condition	Min.	Тур.	Max.	unit	-
Response time		Tr+ Tf	Ta = 25°C θX, θY = 0°	-	50	70	ms	Note2
	Тор	θY+	_	-	45	-		
	Bottom	θY-		-	50	-	Dog	Noto4
	Left	θХ-		-	50	-	Deg.	NOLE4
	Right	θX+		-	50	-		
Contrast rati	0	CR	Ta = 25°C θX , θY = 0°	200	250	-	-	Note3
	\//bito	Х	-	0.244	0.294	0.344		
	vvnite	Y		0.259	0.309	0.359	- - -	
	Dod	Х		0.577	0.627	0.677		
Color of CIE	Reu	Y		0.310	0.360	0.410		
(With B/L)	Green	Х	-	0.282	0.332	0.382		
		Y		0.506	0.556	0.606		
	Dhia	Х		0.091	0.141	0.191		NoteA
	Diue	Y		0.040	0.090	0.140		
Average Brightness								
Pattern=white display		IV	IF=20 mA	180	200	-	cd/m <sup>2</sup>	
(With B/L)								
Uniformity (With B/L)*1		В	IF=20 mA	70	-	-	%	

Note A:

- \*1 : B=B(min) / B(max)
- \*2 : Measurement Condition for Optical Characteristics:
  - a : Environment: 25 ±5 / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.
  - b : Measurement Distance:  $500 \pm 50 \text{ mm}$  , ( $\theta$ = 0°)
  - c : Equipment: TOPCON BM-7 fast , (field 1°) , after 10 minutes operation.
  - d : The uncertainty of the C.I.E coordinate measurement  $\pm 0.01$  , Average Brightness  $\pm\,4\%$







Note1: To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

Refer to figure as below:



Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

Contrast ratio (CR) = Photo detector output when LCD is at "White" state Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle: Refer to figure as below:





## 1.6 Backlight Characteristics

#### **Maximum Ratings**

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25	-	30	mA
Reverse Voltage	VR	Ta =25	-	5	V
Power Dissipation	PD	Ta =25	-	0.720	W

#### Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF		18.0	19.8	21.0	V
Average Brightness (without LCD)	IV IF= 20 mA	3000	3300	-	cd/m <sup>2</sup>	
CIE Color Coordinate	Х		-	0.30	-	
(Without LCD)	Y		-	0.30	-	-
Color			White			





## 1.7 Touch Panel Characteristics

1	Input Method and Activation Force	Stylus < 80grams and Finger < 80grams		
2	Typical Optical	Visible Light Transmission : >80%		
2	Characteristics	Haze : 10%(typ)		
		1. Operating Voltage 7V or less		
		2. Circuit close resistance X : 300~900 ohm		
2	Electrical Specifications	Y : 200~800 ohm		
5		3. Circuit open resistance > 10 Mohm at 25V DC		
		4. Contact bounce < 20ms		
		<ol><li>Operative resistance ≤ 2.0 kohm</li></ol>		
4	Linearity Tolerance	X≤1.5% (maximum), Y≤1.5% (maximum)		
		Operating Temperature -20°C ~ +70°C		
F	Environment Specification	(Operating Humidity: 20%~90% RH)		
5		Storage Temperature -30°C ~ +80°C		
		(Storage Humidity: 10%~90% RH)		



# 2. MODULE STRUCTURE

## 2.1 Counter Drawing

#### 2.1.1 LCM Mechanical Diagram

\* See Appendix

#### 2.1.2 Block Diagram





# 2.2 Interface Pin Description

Pin No.	Symbol	Function
1	VBL-	Power supply for LED Backlight cathode input
2	VBL-	Power supply for LED Backlight cathode input
3	VBL+	Power supply for LED Backlight anode input
4	VBL+	Power supply for LED Backlight anode input
5	NC	Not used , Must be open
6	/RESET	Hardware reset
7	NC	Not used , Must be open. (Output Pin ,POL output.)
8	Y1	Touch panel TOP
9	X1	Touch panel RIGHT
10	Y2	Touch panel BOTTOM
11	X2	Touch panel LEFT
12	B0	Blue data bit 0
13	B1	Blue data bit 1
14	B2	Blue data bit 2
15	B3	Blue data bit 3
16	B4	Blue data bit 4
17	B5	Blue data bit 5
18	B6	Blue data bit 6
19	B7	Blue data bit 7
20	G0	Green data bit 0
21	G1	Green data bit 1
22	G2	Green data bit 2
23	G3	Green data bit 3
24	G4	Green data bit 4
25	G5	Green data bit 5
26	G6	Green data bit 6
27	G7	Green data bit 7
28	R0	Red data bit 0
29	R1	Red data bit 1
30	R2	Red data bit 2



31	R3	Red data bit 3
32	R4	Red data bit 4
33	R5	Red data bit 5
34	R6	Red data bit 6
35	R7	Red data bit 7
36	HSYNC	Horizontal sync input
37	VSYNC	Vertical sync input
38	DOTCLK	Dot data clock
39	VDDIO	Digital power
40	VDDIO	Digital power
41	VDDIO	Digital power
42	VDDIO	Digital power
43	SPENA	Serial port data enable signal
44	NC	Not used , Must be open
45	NC	Not used , Must be open (Output Pin ,VGL ,Gate off power.)
46	NC	Not used , Must be open
47	NC	Not used , Must be open (Output Pin ,VGH, Gate on power.)
		Display shut down pin to put the driver into sleep mode. A sharp
	CULUT	falling edge must be provided to such pin when IC power on.
19		Internal pull low.
40	3101	- Connect to VDDIO for sleep mode
		- Connect to VSS for normal operating mode
		(Refer to Power Up Sequence)
49	SPCLK	Serial data clock
50	SPDAT	Serial data
51	NC	Not used , Must be open (Output Pin ,VCOM power.)
52	ENB	Data enable control
53	VSS	Ground
54	VSS	Ground

POWERTIP

# 2.3 Timing Characteristics



#### **Pixel timing**

Characteristics	Symbol	Symbol Min		Тур		Max		Unit
Gharacteristics	Symbol	24 bit	8 bit	24 bit	8 bit	24 bit	8 bit	Unit
DOTCLK Frequency	<b>fDOTCLK</b>			6.5	19.5	10		MHz
DOTCLK Period	tDOTCLK	100	33.3	154	51.3			<b>ns</b>
Vertical Sync Setup Time	tvsys	20 .	10					ns
Vertical Sync Hold Time	tvsyb	20	. 10					<b>ns</b>
Horizontal Sync Setup Time	thsys	20	10					ns
Horizontal Sync Hold Time	thsyh	20	. 10					ns
Phase difference of Sync Signal Falling Edge	thv				•	24	40	tDOTCLK
DOTCLK Low Period	tCKL	50	15					<b>ns</b>
DOTCLK High Period	tCKH	50	15					ns
Data Setup Time	tds	12	10					ns
Data hold Time	tdh	12	10					<b>ns</b>
Reset pulse width	tRES	1	0					us

Note: External clock source must be provided to DOTCLK pin of HX8238-A. The driver will not operate if absent of the clocking signal.

#### **Pixel timing**

Note : The interface of this module can drive by digital 24-bit data.





Note: The example transmit "0x1264h" to register R28h. SPID connected to VSS.

#### SPI interface timing diagram & transaction example

Symbol	Min	Тур	Max	Unit
fclk			20	MHz
tclk	50			ns
tsl	25		· · · · · · · · · · · · · · · · · · ·	ns
tsh	25			ns
tcss				ns
tcsh	10			ns
tcsd	20			ns
tds	5			ns
tdh	10			ns
	Symbol fclk tclk tsl tsh tcss tcsh tcsh tcsd tds tdh	Symbol         Min           fclk         -           tclk         50           tsl         25           tsh         25           tcss         0           tcsh         10           tcsd         20           tds         5           tds         5           tdh         10	Symbol         Min         Typ           fclk         -         -           tclk         50         -           tsl         25         -           tsh         25         -           tcsh         10         -           tcsh         10         -           tcsh         10         -           tcsd         20         -           tds         5         -           tdh         10         -	Symbol         Min         Typ         Max           fclk         -         -         20           tclk         50         -         -           tsl         25         -         -           tsh         25         -         -           tcsh         25         -         -           tcsh         25         -         -           tcss         0         -         -           tcsh         10         -         -           tcsd         20         -         -           tds         5         -         -           tdh         10         -         -

SPI timing



2.4 Power Sequence 2.4.1 Power up sequence



Characteristics	Symbol	Min	Тур	Max	Units
VDDD / VDDIO on to falling edge of SHUT	tp-shut	1			us
DOTCLK	tclk-shut	<b>1</b>			clk
Falling edge of SHUT to LCD power on	tshut-lcd			128	ms
Falling edge of SHUT to display start				14	frame
- 1 line: 408 clk - 1 frame: 262 line -DOTCLK = 6.5MHz	tshut-on	-	166	232.4	ms

Note: It is necessary to input DOTCLK before the falling edge of SHUT. Display starts at 10th falling edge of VSTNC after the falling edge of SHUT.

Note: 1、The voltage of VDD be boosted from VDDIO.



2.4.2 Power down sequence



Characteristics	Symbol	Min	Тур	Max	Uni
Rising edge of SHUT to display off	and the state of t	2			frame
<ul> <li>1 line: 408 clk</li> <li>1 frame: 262 line</li> <li>DOTCLK = 6.5MHz</li> </ul>	tshut-off	33.4	-	-	ms
Input-signal-off to VDDD / VDDIO off	toff-vdd	1	1919 - 1919 - 1919 - 1919 - 1919 - 1919 - 1919 - 1919 - 1919 - 1919 - 1919 - 1919 - 1919 - 1919 - 1919 - 1919 -	1.500 million - 1000 million (1	US

Note: DOTCLK must be maintained at lease 2 frames after the rising edge of SHUT.

Display become off at the 2nd falling edge of VSTNC after the falling edge of SHUT.

If RESET signal is necessary for power down, provide it after the 2-frames-cycle of the SHUT period.

#### Note: 1、The voltage of VDD be boosted from VDDIO.



### 2.5 Reference Initial code

Register(0x0001); Data(0x7300);

Register(0x0002); Data(0x0200);

Register(0x0003); Data(0x6364);

Register(0x0004); Data(0x04C7);

Register(0x0005); Data(0xFC80);

Register(0x00,0x0A); Data(0x4008);

Register(0x00,0x0D); Data(0x3229);

Register(0x00,0x0E); Data(0x3200);

Register(0x00,0x1E); Data(0x00D2); //Contrast/Brightness control;

0D); //Power control(2);

0x00,0x0E); //Power control(3);VOML

x00,0x1E); //Power control(4);COMH



# **3. QUALITY ASSURANCE SYSTEM**

## 3.1 Quality Assurance Flow Chart









# 3.2 Inspection Specification

#### 1. Inspection Specification

- ◆Scope : The document shall be applied to TFT-LCD Module for 3, 5" ~10" (Ver. 02).
- ◆Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- Equipment : Gauge \ MIL-STD \ Powertip Tester \ Sample
- ◆Defect Level : Major Defect AQL : 0.4 ; Minor Defect AQL : 1.5
- ♦OUT Going Defect Level : Sampling.
- Standard of the product appearance test :
  - a. Manner of appearance test :
  - (1). The test best be under 20W×2 fluorescent light , and distance of view must be at 30 cm.
  - (2). The test direction is base on about around  $45^\circ$  of vertical line.



(3). Definition of area.



A area : viewing area

B area : Outside of viewing area

(4). Standard of inspection : (Unit : mm)



<b>♦</b> Spee	Specification For TFT-LCD Module 3. 5" ~10" : (Ve						Ver.02)	
NO	Item			Criterio	on		Level	
		1.1The pro	part nur oduction	mber is inconsistent	with work order of		Major	
01	Product condition	1. 2 Miz	xed prod	uct types.			Major	
		1. 3 Ass	embled i	n inverse direction.			Major	
02	Quantity	2. 1The	quantity	y is inconsistent with	work order of productio	)n.	Major	
03	Outline dimension	3.1 Pro dia	oduct dir Igram.	mension and structu	ire must conform to stru	ucture	Major	
		4. 1 Mis	ssing line	character and icon.			Major	
	Electrical Testing	4. 2 No function or no display.						
04		4. 3 Display malfunction.					Major	
		4.4 LCD viewing angle defect.					Major	
		4.5 Current consumption exceeds product specifications.					Major	
				Item	Acceptance (Q'ty)			
	Dat dafaat			Bright Dot	≦ 4			
	Dot defect		Dot	Dark Dot	≦ 5			
	(Bright dot \		Defect	Joint Dot	≦ 3			
05	Dark dot)			Total	≦ 7		Minor	
	On -display	5.1 Ins	5.1 Inspection pattern : full white , full black , Red , Green and					
				blue screen:	5.			
		5.2 It is	s defined	as dot defect if defe	ct area $>1/2$ dot.			
		5. 3 The	e distanc	e between two dot do	efect ≧5 mm.			



<b>♦</b> Speci	Specification For TFT-LCD Module 3. 5" ~10" : (Ver						
NO	Item		Criterion				
06	Black or white dot $\cdot$ scratch $\cdot$ contamination Round type x $y\Phi = (x+y)/2Line typeL$ $W$	<ul> <li>6. 1 Round type (</li> <li>Dimension</li> <li>0. 25 &lt;</li> <li>6. 2 Line type( N</li> <li>Length (L)</li> <li></li> <li>L ≤ 10. 0</li> <li>L ≤ 5. 0</li> <li></li> </ul>	(Non-display o (diameter : $\Phi$ $\Phi \leq 0.25$ $\Phi \geq 0.50$ $\Phi > 0.50$ Total on-display or d Width W 0.03 < W 0.05 < W W Total	r display) : ) According isplay) : (W) $f \leq 0.03$ $f \leq 0.05$ $\leq 0.10$ r > 0.10	eptance (Q'ty) Ignore 5 0 5 Acceptance (Q'ty) Ignore 4 2 As round type 5		Minor
07	Polarizer Bubble	Dimension (d 0. 25 < 0 0. 50 < 0 To	diameter : $\Phi$ ) $\Phi \leq 0.25$ $\Phi \leq 0.50$ $\Phi \leq 0.80$ $\Phi > 0.80$ otal	Acc	eptance (Q'ty) Ignore 4 1 0 5		Minor







NO	Item	Criterion					
		Symbols : X : The length of crack Z : The thickness of crack t : The thickness of glass 8.1.2 Corner crack : X = Z Y : The width of crack W : terminal length a : LCD side length	•				
		X Y Z					
		$ \leq 1/5 \text{ a} \qquad \begin{array}{c} \text{Crack can't enter} \\ \text{viewing area} \end{array} \qquad \qquad \mathbf{Z}  \leq 1/2 \text{ t} \\ \end{array} $					
		$\leq 1/5 \text{ a}  \begin{array}{c} \text{Crack can't exceed the} \\ \text{half of SP width.} \end{array}  1/2 \text{ t} < \text{Z}  \leq 2 \text{ t} \end{array}$					
08	The crack of glass						
		8.2 Protrusion over terminal :					
		X Y Z	- 1				
		Front $\leq a$ $\leq 1/2$ W $\leq t$	- 1				
		<b>Back</b> $\leq a$ $\leq W$ $\leq 1/2 t$					



## ◆Specification For TFT-LCD Module 3, 5″ ~10″:





◆Specification For TFT-LCD Module 3, 5″~10″: (Ver							
NO	Item	Criterion	Level				
09		9. 1 Backlight can't work normally.	Major				
	Backlight elements	9. 2 Backlight doesn't light or color is wrong.	Major				
		9. 3 Illumination source flickers when lit.	Major				
	10 10 10 10 10 10 10 10 10 10	10. 1 Pin type < quantity < dimension must match type in structure diagram.	Major				
		10. 2 No short circuits in components on PCB or FPC .	Major				
		10.3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major				
10		10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor				
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor				
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC ) is ≤1.5 mm.	Minor				



# 4. RELIABILITY TEST

## 4.1 Reliability Test Condition

Ver.02

NO.	TEST ITEM	TEST CONDITION			
1	High Temperature Storage Test	Keep in +80 ±2 96 hrs Surrounding temperature, then storage at normal condition 4hrs.			
2	Low Temperature Storage Test	Keep in -30 ±296 hrsSurrounding temperature, then storage at normal condition 4hrs.			
3	High Temperature / High Humidity Storage Test	Keep in +60/ 90% R.H duration for 96 hrsSurrounding temperature, then storage at normal condition 4hrs.(Excluding the polarizer)			
4	ESD Test	Air Discharge:Contact Discharge:Apply 2 KV with 5 timesApply 250 V with 5 timesDischarge for each polarity +/-discharge for each polarity +/-1. Temperature ambiance : 15352. Humidity relative : 30% 60%3. Energy Storage Capacitance(Cs+Cd) : 150pF±10%4. Discharge Resistance(Rd) : 330 ±10%5. Discharge, mode of operation :Single Discharge (time between successive discharges at least1 are)			
5	Temperature Cycling Storage Test	-20       +25       +70       +25         (30mins)       (5mins)       (30mins)       (5mins)         10 Cycle       Surrounding temperature, then storage at normal condition 4hrs.			
6	Vibration Test (Packaged)	<ol> <li>Sine wave 10 55 Hz frequency (1 min)</li> <li>The amplitude of vibration :1.5 mm</li> <li>Each direction (X, Y, Z) duration for 2 Hrs</li> </ol>			
7	Drop Test (Packaged)	Packing Weight (Kg)         Drop Height (cm)           0 ~ 45.4         122           45.4 ~ 90.8         76           90.8 ~ 454         61           Over 454         46   Drop direction : 1 corner / 3 edges / 6 sides each 1 times			



# **5. PRECAUTION RELATING PRODUCT HANDLING**

## 5.1 SAFETY

- 5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

## **5.2 HANDLING**

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands , this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10 and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM .

## 5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is  $25 \pm 5$  and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush , shake , or jolt the module.

## **5.4 TERMS OF WARRANTY**

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



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